

[10191/2277]

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Inventor(s) : Richard SPITZ  
Serial No. : To Be Assigned  
Filed : Herewith  
For : SEMICONDUCTOR ELEMENT AND METHOD OF  
MANUFACTURING THE SEMICONDUCTOR  
COMPONENT  
Examiner : To Be Assigned  
Art Unit : To Be Assigned

Assistant Commissioner for Patents  
Washington, D.C. 20231

**PRELIMINARY AMENDMENT AND**  
**37 C.F.R. § 1.125 SUBSTITUTE SPECIFICATION STATEMENT**

SIR:

Please amend the above-identified application before examination, as set forth below.

**IN THE SPECIFICATION AND ABSTRACT:**

In accordance with 37 C.F.R. § 1.121(b)(3), a Substitute Specification (including the Abstract, but without claims) accompanies this response. It is respectfully requested that the Substitute Specification (including Abstract) be entered to replace the Specification of record.

**IN THE CLAIMS:**

~~Please cancel original claims 1-15 and please cancel substitute~~  
claims 1-8, without prejudice.

Please add the following new claims:

2LS94613017